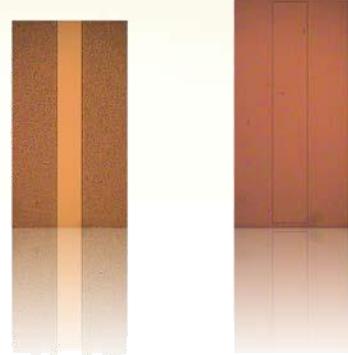




808nm 200mW Chip

Introduction

808nm laser diode is packaged on standard C-Mount heat sink, or better heat sink ones, which also can be adopted in Medical Illumination, Target Indication, Laser Show, Scientific Research.



Parameters (25°C)

808nm 200mW Chip			
	Parameter	Unit	CLDM-0808-200m
Optical Parameter	Output Power P_o	mW	200
	Center Wavelength λ_c	nm	808 ± 4
	Beam Divergence $\theta_{\perp} \times \theta_{\parallel}$	deg	40x10
	COD	W	≥ 0.40
Chip Size	Emitting Area	μm	28
	Period	μm	350
	Cavity Length	μm	700
Electrical Parameter	Slope Efficiency E_s	W/A	≥ 0.95
	Threshold Current I_{th}	A	≤ 0.10
	Operating Current I_f	A	≤ 0.32
	Operating Voltage V_f	V	≤ 2.00





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Notice

1. Item notice: CLDM(item model)-*****(center wavelength)-*****(output power)
2. Data sheet is basis on the result of under 25°C testing.
3. Data sheet is basis on the TO package testing.
4. For more information, please contact Hi-Tech Optoelectronics Co., Ltd.



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